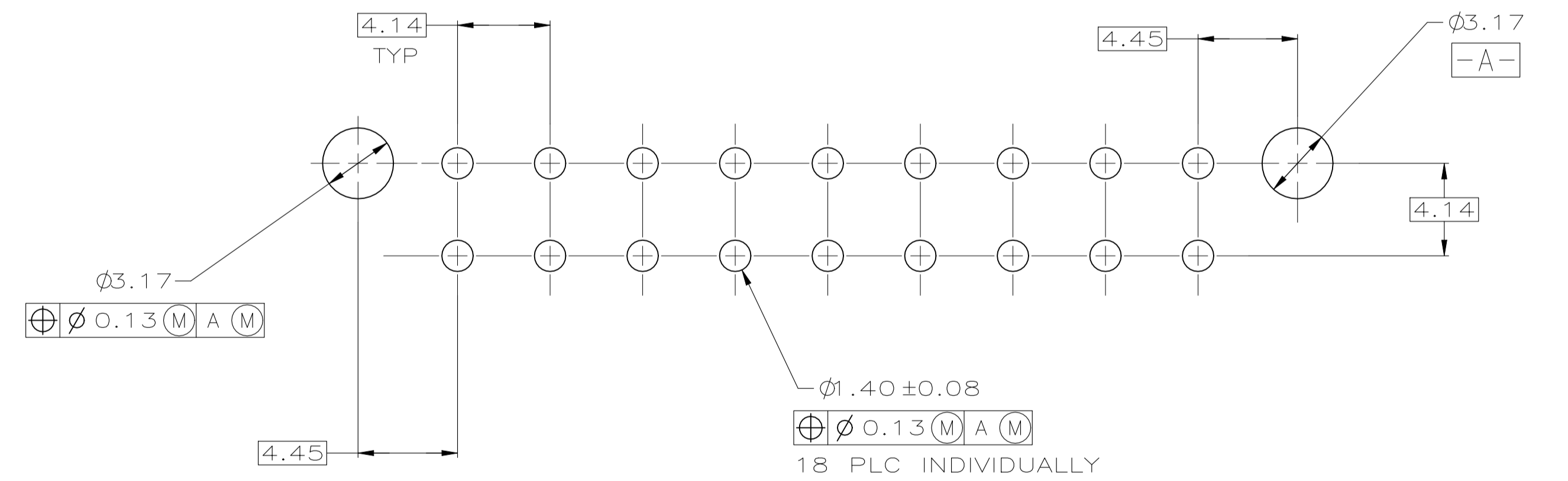


1. PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 108-11-3.
- △ 0.00381 MIN MATTE TIN LEAD OVER 0.00127 MIN NICKEL.
- △ 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
- △ 0.00381 MIN MATTE TIN OVER 0.00127 MIN NICKEL.
- △ 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.



RECOMMENDED MOUNTING HOLE PATTERN FOR 1.57 THICK P.C. BOARD

	BRASS, GOLD △	NYLON, 94V-0, WHITE	1-794076-1
	BRASS, TIN △	NYLON, 94V-0, WHITE	1-794076-0
SUPERSEDE WITH 1-794076-1	BRASS, GOLD △	NYLON, 94V-0, WHITE	794076-2
SUPERSEDE WITH 1-794076-0	BRASS, TIN LEAD △	NYLON, 94V-0, WHITE	794076-1

PIN CONTACT MATERIAL AND FINISH		HOUSING MATERIAL AND COLOR	PART NUMBER
THIS DRAWING IS A CONTROLLED DOCUMENT.			
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED:	
		0. PLC ± - 1. PLC ± - 2. PLC ± 0.13 3. PLC ± - 4. PLC ± - ANGLES ± -	
MATERIAL SEE TABLE	FINISH SEE TABLE	WEIGHT	RESTRICTED TO
CUSTOMER DRAWING		SCALE 5:1	SHEET 1 of 1 REV E1

REVISIONS				
REV	DESCRIPTION	DATE	BY	APP'D
E1	REVISED PER ECR-24-196907	26JUL2024	MV	JP